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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Octavian ANTON et al

Serial No.: New

Filing Date: June 19, 2001

For: MICROPOROUS HEAT INSULATION BODY

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BHA

PRELIMINARY AMENDMENT

Assistant Commissioner of Patents  
Washington, D.C. 20231

Sir:

Prior to initial examination, please amend the above-identified application as follows:

IN THE CLAIMS

Please amend claims 3-7 as follows:

3. (amended) The microporous heat insulation body according to claim 1, characterized in that said further additives are from 0 to 30 % by weight of an opacifier, from 0 to 10 % by weight of a fibrous material, and from 0 to 15% by weight of an inorganic binder.

*al*